

A10581-40

101526673

Attorney Docket No. 8029-1072

Form PTO-1595

09-06-2005

VER SHEET

U.S. Department of Commerce
U.S. Patent and Trademark Office



LY DT01 Rec'd PCT/PT 0 4 MAR 2005

To the Honorable Commissi

103074676

ord the attached original documents or copy thereof.

3.4.05

1. Name of Conveying Party(ies):
Hirokazu TOHYA
Koichiro MASUDA
Hideki SHIMIZU

Additional name(s) of conveying party(ies) attached?
 Yes No

2. Name and address of receiving party(ies)
 Name: **NEC Corporation**
 Address: **7-1, Shiba 5-chome**
Minato-ku
Tokyo
Japan

3. Nature of Conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other: _____
 Execution Date: **February 24, 2005**

Additional name(s) and address(es) attached?
 Yes No

4. Application number(s) or patent number(s):
 This document is being filed with a new application, the execution date of the application is: **February 24, 2005**

A. Patent Application No(s). B. Patent No(s).

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
Customer No.: 00466
YOUNG & THOMPSON
Second Floor
745 South 23rd Street
Arlington, VA 22202
Phone: 703-521-2297
Fax: 703-685-0573

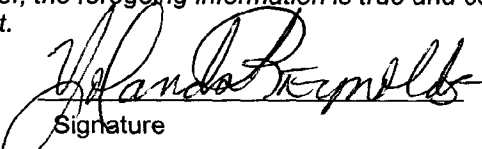
6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41)..... **\$40.00**
 Enclosed
 Authorized to be charged to deposit account

8. Deposit Account No. **25-0120**
 (Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Yolanda Reynolds  **March 4, 2005**
 Name of Person Signing Signature Date

Total number of pages including cover sheet, attachments, and documents: **2**

Y&T March 4, 2005

PATENT
REEL: 016941 FRAME: 0267

ASSIGNMENT

WHEREAS,

HIROKAZU TOHYA, KOICHIRO MASUDA and HIDEKI SHIMIZU
of Tokyo, Japan

hereafter referred to as "applicant(s)", have invented certain new and useful improvements in
STRIPLINE DEVICE, PRINTED WIRING BOARD MOUNTING MEMBER, CIRCUIT BOARD,
SEMICONDUCTOR PACKAGE, AND METHOD OF FORMING SAME

(a) for which an application for a United States patent was filed on
_____, Application No. _____,

(b) for which an application for a United States patent was executed on
_____.

WHEREAS, NEC Corporation
whose address is 7-1, Shiba 5-chome, Minato-ku, Tokyo, Japan

hereinafter referred to as "assignee(s)", is desirous of acquiring the entire right, title and interest in and to the same,

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00), the receipt whereof is acknowledged, and other good and valuable consideration, applicant(s), by these presents, do(es) hereby sell, assign and transfer unto said assignee(s) the full and exclusive right to the said invention in the United States and the entire right, title and interest in and to any and all patents which may be granted therefore in the United States, for its sole use and behoof, and for the use and behoof of its legal representatives, to the full end of the term for which said patents may be granted, as fully and entirely as the same would have been held by applicant(s) had this assignment and sale not been made.

Applicant(s) hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue said United States patents to said assignee(s).

Date 2/24/2005

Hirokazu Tohya
(signature) HIROKAZU TOHYA

Date 2/24/2005

Koichiro Masuda
(signature) KOICHIRO MASUDA

Date 2/24/2005

Hideki Shimizu
(signature) HIDEKI SHIMIZU

Witness:
Date 2/24/2005

Masato Kimura
(signature)

Date 2/24/2005

Shinji Masuda
(signature)